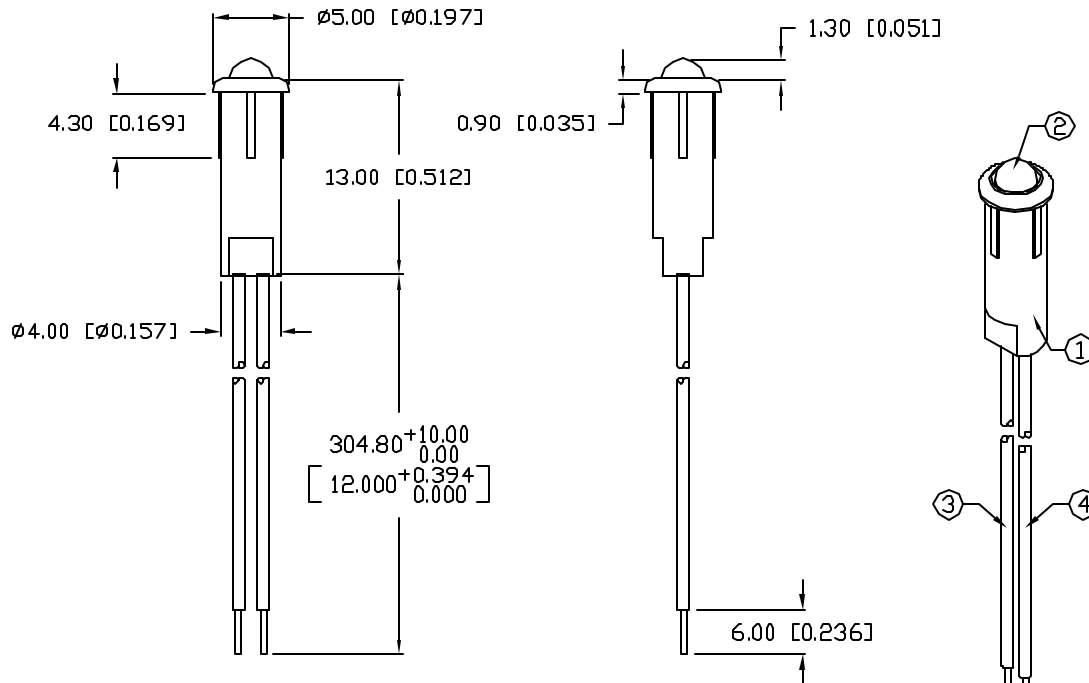


UNCONTROLLED DOCUMENT

PART NUMBER
SSI-LXH312ID-300

REV.
A

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10BRDR. & REDRAWN.	7.12.01



NOTES:

- SSH-LXH3121 HOLDER, BLACK NYLON 94-V.
- SSL-LX3044ID LED, LEADS CUT TO 5mm.
- ANODE LEAD: LXP-WST26RDT0C, RED INSULATED LEAD, 26 AWG, CUT 310mm LONG, STRIP 3.0mm & 6mm.
- CATHODE LEAD: LXP-WST26BLT0C, BLACK INSULATED LEAD, 26 AWG, CUT 310mm LONG, STRIP 3.0mm & 6mm.
- MOUNTING HOLE: $\phi 0.170'' - \phi 0.174''$

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		635		nm	
FORWARD VOLTAGE		2.0	2.8	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		30		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.6	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= ^{+0.00} _{-0.00} DECIMAL PRECISION, MAX= ^{+0.00} _{-0.00} DECIMAL PRECISION

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T-3mm LED BLACK PANEL INDICATOR WITH 12" WIRE LEADS,
635 HIGH INTENSITY RED LED, RED DIFFUSED LENS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: GT	CHECKED BY:	APPROVED BY:	DATE: 2.27.01
			PAGE: 1 OF 1
			SCALE: N/A